

Technical Data Sheet

Topolymer® CM135B

CM135B with Medium molecular weight and Mooney viscosity between 75 and 85, It show superior mechanical performances and good processibility in processing.

Tech Specs

Items	UNIT	INDEX	Test Method
Chlorine content	%	35±1	ISO 7725
Heat of Fusion	J/g	≤2.0	DSC
Volatile Matter component	%	≤0.4	ISO 1269
Rate of filtration(40 mesh)	%	≥98	--
Shore Hardness A	°	≤57	ISO 7619
Tensile strength	Mpa	≥8.0	ISO 37
Elongation at break	%	≥700	ISO 37
Mooney Viscosity	ML(125°C 1+4)	75-85	--
Whiteness E457	°	≥80	--

Applications

It is widely used for hose, wire/cable and molded products. Not only it can be used as halide rubber solely but also it can be mixed with CR, CSM, NBR, SBR and NR at any proportion.





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Package and Storage

25kg PP valve bag ;

The product can be stored under appropriate conditions for two years. But please keep products store in a dry ventilated environment (temperature should not exceed 30°C, in low humidity). Inappropriate storage environment may cause agglomeration. Especially at high temperatures & high humidity, it is recommended not to stack more than 30 days long, it may increase agglomeration phenomenon. Agglomeration does not affect the quality and performance, not a quality problem, but agglomeration material is smashed before using .

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